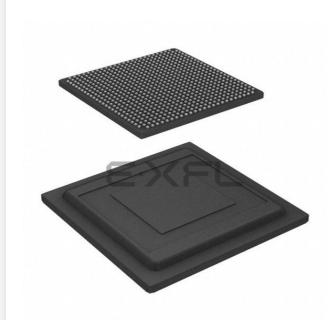
# E·XFL

#### Intel - 5AGXMA5D4F27I3N Datasheet



Welcome to E-XFL.COM

#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Details	
Product Status	Obsolete
Number of LABs/CLBs	8962
Number of Logic Elements/Cells	190000
Total RAM Bits	13284352
Number of I/O	336
Number of Gates	-
Voltage - Supply	1.12V ~ 1.18V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5agxma5d4f27i3n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## Arria V GX, GT, SX, and ST Device Datasheet



This datasheet describes the electrical characteristics, switching characteristics, configuration specifications, and I/O timing for Arria® V devices.

Arria V devices are offered in commercial and industrial grades. Commercial devices are offered in -C4 (fastest), -C5, and -C6 speed grades. Industrial grade devices are offered in the -I3 and -I5 speed grades.

#### **Related Information**

#### Arria V Device Overview

Provides more information about the densities and packages of devices in the Arria V family.

## **Electrical Characteristics**

The following sections describe the operating conditions and power consumption of Arria V devices.

## **Operating Conditions**

Arria V devices are rated according to a set of defined parameters. To maintain the highest possible performance and reliability of the Arria V devices, you must consider the operating requirements described in this section.

#### **Absolute Maximum Ratings**

This section defines the maximum operating conditions for Arria V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms.

The functional operation of the device is not implied for these conditions.

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I/O Standard	V <sub>IL</sub>	V <sub>IL(DC)</sub> (V) V <sub>IH(DC)</sub> (V)		<sub>C)</sub> (V)	V <sub>IL(AC)</sub> (V)	V <sub>IH(AC)</sub> (V)	V <sub>OL</sub> (V)	V <sub>OH</sub> (V)	I <sub>OL</sub> <sup>(14)</sup>	I <sub>OH</sub> <sup>(14)</sup> (mA)
	Min	Max	Min	Max	Max	Min	Max	Min	(mA)	OH (יעייי)
HSTL-15 Class II	—	V <sub>REF</sub> – 0.1	$V_{REF} + 0.1$	—	V <sub>REF</sub> – 0.2	$V_{REF} + 0.2$	0.4	V <sub>CCIO</sub> – 0.4	16	-16
HSTL-12 Class I	-0.15	V <sub>REF</sub> – 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> – 0.15	V <sub>REF</sub> + 0.15	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	8	-8
HSTL-12 Class II	-0.15	V <sub>REF</sub> – 0.08	V <sub>REF</sub> + 0.08	V <sub>CCIO</sub> + 0.15	V <sub>REF</sub> – 0.15	V <sub>REF</sub> + 0.15	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	16	-16
HSUL-12	—	V <sub>REF</sub> - 0.13	V <sub>REF</sub> + 0.13	_	V <sub>REF</sub> – 0.22	$V_{REF} + 0.22$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$		_

#### **Differential SSTL I/O Standards**

Table 1-17: Differential SSTL I/O Standards for Arria V Devices

I/O Standard	I/O Standard			V <sub>SW</sub>	<sub>ING(DC)</sub> (V)		$V_{X(AC)}(V)$		V <sub>SWING(AC)</sub> (V)	
	Min	Тур	Max	Min	Мах	Min	Тур	Мах	Min	Max
SSTL-2 Class I, II	2.375	2.5	2.625	0.3	$V_{CCIO} + 0.6$	V <sub>CCIO</sub> /2 – 0.2	_	V <sub>CCIO</sub> /2 + 0.2	0.62	$V_{CCIO} + 0.6$
SSTL-18 Class I, II	1.71	1.8	1.89	0.25	$V_{CCIO} + 0.6$	V <sub>CCIO</sub> /2 – 0.175	_	V <sub>CCIO</sub> /2 + 0.175	0.5	$V_{CCIO} + 0.6$
SSTL-15 Class I, II	1.425	1.5	1.575	0.2	(15)	V <sub>CCIO</sub> /2 – 0.15	—	V <sub>CCIO</sub> /2 + 0.15	$2(V_{IH(AC)} - V_{REF})$	$2(V_{IL(AC)} - V_{REF})$
SSTL-135	1.283	1.35	1.45	0.18	(15)	V <sub>CCIO</sub> /2 – 0.15	V <sub>CCIO</sub> /2	V <sub>CCIO</sub> /2 + 0.15	2(V <sub>IH(AC)</sub> – V <sub>REF</sub> )	$2(V_{IL(AC)} - V_{REF})$

<sup>&</sup>lt;sup>(14)</sup> To meet the I<sub>OL</sub> and I<sub>OH</sub> specifications, you must set the current strength settings accordingly. For example, to meet the SSTL15CI specification (8 mA), you should set the current strength settings to 8 mA. Setting at lower current strength may not meet the I<sub>OL</sub> and I<sub>OH</sub> specifications in the datasheet.



 $<sup>^{(15)}</sup>$  The maximum value for  $V_{SWING(DC)}$  is not defined. However, each single-ended signal needs to be within the respective single-ended limits ( $V_{IH(DC)}$  and  $V_{IL(DC)}$ ).

Symbol/Description	Condition	Trans	sceiver Speed Gr	ade 4	Transceiver Speed Grade 6			Unit
Symbol/Description	Condition	Min	Тур	Max	Min	Тур	Max	onic
Spread-spectrum modulating clock frequency	PCI Express <sup>®</sup> (PCIe)	30		33	30	_	33	kHz
Spread-spectrum downspread	PCIe	—	0 to -0.5%	_		0 to -0.5%	—	
On-chip termination resistors	_	_	100		_	100	—	Ω
V <sub>ICM</sub> (AC coupled)		—	1.1/1.15 <sup>(26)</sup>		_	1.1/1.15 <sup>(26)</sup>	—	V
V <sub>ICM</sub> (DC coupled)	HCSL I/O standard for the PCIe reference clock	250	_	550	250	_	550	mV
	10 Hz	—	_	-50	_	—	-50	dBc/Hz
	100 Hz	_	_	-80	_	—	-80	dBc/Hz
Transmitter REFCLK phase	1 KHz	—		-110	_	—	-110	dBc/Hz
noise <sup>(27)</sup>	10 KHz	_	_	-120	_	_	-120	dBc/Hz
	100 KHz	—	_	-120	_	—	-120	dBc/Hz
	≥1 MHz			-130	_	_	-130	dBc/Hz
R <sub>REF</sub>	—	—	2000 ±1%		—	2000 ±1%	_	Ω



<sup>&</sup>lt;sup>(26)</sup> For data rate  $\leq$  3.2 Gbps, connect V<sub>CCR\_GXBL/R</sub> to either 1.1-V or 1.15-V power supply. For data rate > 3.2 Gbps, connect V<sub>CCR\_GXBL/R</sub> to a 1.15-V power supply. For details, refer to the Arria V GT, GX, ST, and SX Device Family Pin Connection Guidelines.

<sup>&</sup>lt;sup>(27)</sup> The transmitter REFCLK phase jitter is 30 ps p-p at bit error rate (BER)  $10^{-12}$ .

#### Table 1-21: Transceiver Clocks Specifications for Arria V GX and SX Devices

Symbol/Description	Condition	Transceiver Speed Grade 4			Transceiver Speed Grade 6			Unit	
	Condition	Min	Тур	Мах	Min	Тур	Max	Ont	
fixedclk clock frequency	PCIe Receiver Detect	—	125	—	—	125	_	MHz	
Transceiver Reconfigura- tion Controller IP (mgmt_ clk_clk) clock frequency	—	75	_	125	75	_	125	MHz	

## Table 1-22: Receiver Specifications for Arria V GX and SX Devices

Sumbol/Doccription	Condition	Transc	eiver Speed G	irade 4	Transceiver Speed Grade 6			Unit
Symbol/Description	Condition	Min	Тур	Max	Min	Тур	Max	Onit
Supported I/O standards		1.5 V PCML, 2.5 V PCML, LVPECL, and LVDS						
Data rate <sup>(28)</sup>	_	611	_	6553.6	611	_	3125	Mbps
Absolute $V_{MAX}$ for a receiver pin <sup>(29)</sup>	_		_	1.2	_	_	1.2	V
Absolute V <sub>MIN</sub> for a receiver pin	_	-0.4	_	_	-0.4	_	_	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) before device configuration	_			1.6			1.6	V
Maximum peak-to-peak differential input voltage V <sub>ID</sub> (diff p-p) after device configuration	_			2.2			2.2	V



 <sup>&</sup>lt;sup>(28)</sup> To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.
 <sup>(29)</sup> The device cannot tolerate prolonged operation at this absolute maximum.

Symbol/Description	Condition	Т	Unit			
Symbol/Description	Condition	Min	Typ Max		onit	
t <sub>LTD_manual</sub> <sup>(51)</sup>	—	4	—	_	μs	
t <sub>LTR_LTD_manual</sub> <sup>(52)</sup>	_	15			μs	
Programmable ppm detector <sup>(53)</sup>	_	±62.5, 100	±62.5, 100, 125, 200, 250, 300, 500, and 1000			
Run length	—	_	_	200	UI	
Programmable equalization AC and DC gain	AC gain setting = 0 to $3^{(54)}$ DC gain setting = 0 to 1	Refer to CTLE Response at Data Rates > 3.25 Gbps across Supported AC Ga and DC Gain for Arria V GX, GT, SX, and ST Devices and CTLE Response Data Rates ≤ 3.25 Gbps across Supported AC Gain and DC Gain for Arria GX, GT, SX, and ST Devices diagrams.				

#### Table 1-29: Transmitter Specifications for Arria V GT and ST Devices

Symbol/Description	Condition	Tran	sceiver Speed Gra	Unit			
	Condition	Min	Тур	Max			
Supported I/O standards	1.5 V PCML						
Data rate (6-Gbps transceiver)	—	611		6553.6	Mbps		
Data rate (10-Gbps transceiver)	_	0.611		10.3125	Gbps		
V <sub>OCM</sub> (AC coupled)	—		650		mV		
V <sub>OCM</sub> (DC coupled)	$\leq$ 3.2 Gbps <sup>(48)</sup>	670	700	730	mV		

<sup>(53)</sup> The rate match FIFO supports only up to  $\pm 300$  ppm.

<sup>(54)</sup> The Quartus Prime software allows AC gain setting = 3 for design with data rate between 611 Mbps and 1.25 Gbps only.

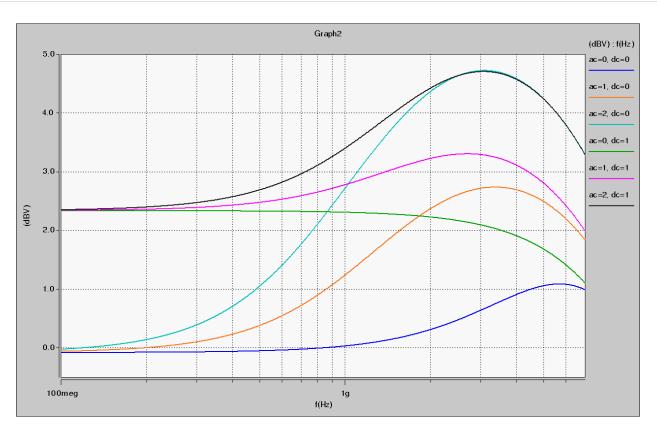


 $<sup>^{(51)}</sup>$  t<sub>LTD\_manual</sub> is the time required for the receiver CDR to start recovering valid data after the rx\_is\_lockedtodata signal goes high when the CDR is functioning in the manual mode.

<sup>(52)</sup> t<sub>LTR\_LTD\_manual</sub> is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx\_is\_lockedtoref signal goes high when the CDR is functioning in the manual mode.

### CTLE Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain

Figure 1-2: Continuous Time-Linear Equalizer (CTLE) Response at Data Rates > 3.25 Gbps across Supported AC Gain and DC Gain for Arria V GX, GT, SX, and ST Devices



Arria V GX, GT, SX, and ST Device Datasheet

**Altera Corporation** 



#### 1-40 Transceiver Compliance Specification

Quartus Prime 1st			Quar	tus Prime V <sub>OD</sub> Se	etting			
Post Tap Pre- Emphasis Setting	10 (200 mV)	20 (400 mV)	30 (600 mV)	35 (700 mV)	40 (800 mV)	45 (900 mV)	50 (1000 mV)	Unit
16	_	_	9.56	7.73	6.49		_	dB
17	_	_	10.43	8.39	7.02		_	dB
18	_		11.23	9.03	7.52		_	dB
19	_		12.18	9.7	8.02		_	dB
20	_	_	13.17	10.34	8.59	_	_	dB
21	_	_	14.2	11.1	_	_	_	dB
22	_		15.38	11.87			_	dB
23	_	_	_	12.67	—		_	dB
24	_			13.48	_		_	dB
25	_			14.37	—		_	dB
26	_	_	_		_	_	_	dB
27	_				_		_	dB
28							_	dB
29	_				—		_	dB
30	_				_		_	dB
31							—	dB

#### **Related Information**

#### SPICE Models for Altera Devices

Provides the Arria V HSSI HSPICE models.

#### **Transceiver Compliance Specification**

The following table lists the physical medium attachment (PMA) specification compliance of all supported protocol for Arria V GX, GT, SX, and ST devices. For more information about the protocol parameter details and compliance specifications, contact your Altera Sales Representative.



### Table 1-34: Transceiver Compliance Specification for All Supported Protocol for Arria V GX, GT, SX, and ST Devices

Protocol	Sub-protocol	Data Rate (Mbps)
	PCIe Gen1	2,500
PCIe	PCIe Gen2	5,000
	PCIe Cable	2,500
XAUI	XAUI 2135	3,125
	SRIO 1250 SR	1,250
	SRIO 1250 LR	1,250
	SRIO 2500 SR	2,500
	SRIO 2500 LR	2,500
	SRIO 3125 SR	3,125
Serial RapidIO <sup>®</sup> (SRIO)	SRIO 3125 LR	3,125
Serial Rapidio (SRIO)	SRIO 5000 SR	5,000
	SRIO 5000 MR	5,000
	SRIO 5000 LR	5,000
	SRIO_6250_SR	6,250
	SRIO_6250_MR	6,250
	SRIO_6250_LR	6,250



## DSP Block Performance Specifications

	Mode		Performance		Unit	
	Moue	–I3, –C4	-I5, -C5	-C6	Onit	
	Independent $9 \times 9$ multiplication	370	310	220	MHz	
	Independent $18 \times 19$ multiplication	370	310	220	MHz	
	Independent 18 × 25 multiplication	370	310	220	MHz	
Modes using One DSP	Independent $20 \times 24$ multiplication	370	310	220	MHz	
Block	Independent $27 \times 27$ multiplication	310	250	200	MHz	
	Two $18 \times 19$ multiplier adder mode	370	310	220	MHz	
	$18 \times 18$ multiplier added summed with 36- bit input	370	310	220	MHz	
Modes using Two DSP Blocks	Complex 18 × 19 multiplication	370	310	220	MHz	

#### Memory Block Performance Specifications

To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL and set to 50% output duty cycle. Use the Quartus Prime software to report timing for the memory block clocking schemes.

When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in  $f_{MAX}$ .

Arria V GX, GT, SX, and ST Device Datasheet



#### **HPS PLL Input Jitter**

Use the following equation to determine the maximum input jitter (peak-to-peak) the HPS PLLs can tolerate. The divide value (N) is the value programmed into the denominator field of the VCO register for each PLL. The PLL input reference clock is divided by this value. The range of the denominator is 1 to 64.

Maximum input jitter = Input clock period × Divide value (N) × 0.02

#### Table 1-50: Examples of Maximum Input Jitter

Input Reference Clock Period	Divide Value (N)	Maximum Jitter	Unit
40 ns	1	0.8	ns
40 ns	2	1.6	ns
40 ns	4	3.2	ns

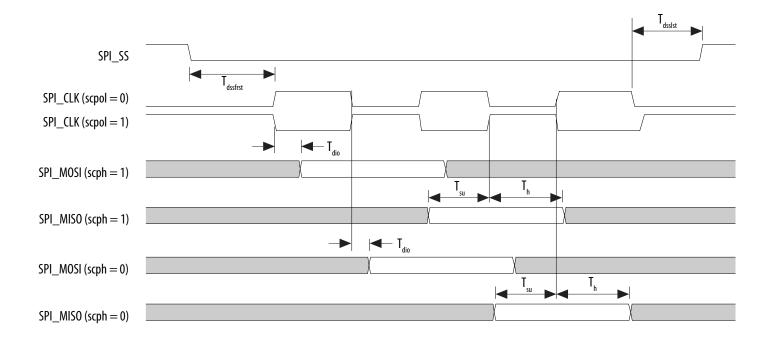
## **Quad SPI Flash Timing Characteristics**

#### Table 1-51: Quad Serial Peripheral Interface (SPI) Flash Timing Requirements for Arria V Devices

Symbol	Description Min Typ		Тур	Мах	Unit
F <sub>clk</sub>	SCLK_OUT clock frequency (External clock)	—	_	108	MHz
T <sub>qspi_clk</sub>	QSPI_CLK clock period (Internal reference clock)	2.32	_		ns
T <sub>dutycycle</sub>	SCLK_OUT duty cycle	45		55	%
T <sub>dssfrst</sub>	Output delay QSPI_SS valid before first clock edge		1/2 cycle of SCLK_OUT		ns
T <sub>dsslst</sub>	Output delay QSPI_SS valid after last clock edge	-1		1	ns
T <sub>dio</sub>	I/O data output delay	-1		1	ns
T <sub>din_start</sub>	Input data valid start			$(2 + R_{delay}) \times T_{qspi\_clk} - 7.52^{(85)}$	ns



#### Figure 1-9: SPI Master Timing Diagram



#### Table 1-53: SPI Slave Timing Requirements for Arria V Devices

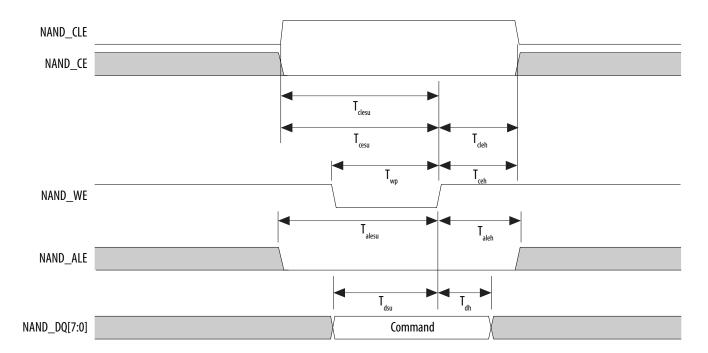
The setup and hold times can be used for Texas Instruments SSP mode and National Semiconductor Microwire mode.

Symbol	Description	Min	Max	Unit
T <sub>clk</sub>	CLK clock period	20		ns
T <sub>s</sub>	MOSI Setup time	5		ns
T <sub>h</sub>	MOSI Hold time	5		ns
T <sub>suss</sub>	Setup time SPI_SS valid before first clock edge	8		ns
T <sub>hss</sub>	Hold time SPI_SS valid after last clock edge	8		ns
T <sub>d</sub>	MISO output delay		6	ns



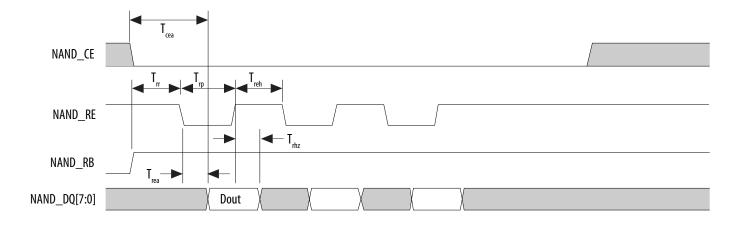
Symbol	Description	Min	Мах	Unit	
T <sub>dh</sub> <sup>(89)</sup>	Data to write enable hold time	5	—	ns	
T <sub>cea</sub>	Chip enable to data access time	ime — 25 ns			
T <sub>rea</sub>	Read enable to data access time	— 16 ns			
T <sub>rhz</sub>	Read enable to data high impedance		100	ns	
T <sub>rr</sub>	Ready to read enable low	20		ns	

## Figure 1-17: NAND Command Latch Timing Diagram





#### Figure 1-20: NAND Data Read Timing Diagram



### **ARM Trace Timing Characteristics**

#### Table 1-61: ARM Trace Timing Requirements for Arria V Devices

Most debugging tools have a mechanism to adjust the capture point of trace data.

Description	Min	Мах	Unit
CLK clock period	12.5	—	ns
CLK maximum duty cycle	45	55	%
CLK to D0 –D7 output data delay	-1	1	ns

## **UART Interface**

The maximum UART baud rate is 6.25 megasymbols per second.

#### **GPIO Interface**

The minimum detectable general-purpose I/O (GPIO) pulse width is 2 µs. The pulse width is based on a debounce clock frequency of 1 MHz.



## **Typical VOD Settings**

The tolerance is +/-20% for all VOD settings ex	cept for settings 2 and below	r.		
Symbol	V <sub>OD</sub> Setting	V <sub>OD</sub> Value (mV)	V <sub>OD</sub> Setting	V <sub>OD</sub> Value (mV)
	0 (166)	0	32	640
	1 <sup>(166)</sup>	20	33	660
	2(166)	40	34	680
	3(166)	60	35	700
	4 <sup>(166)</sup>	80	36	720
	5 <sup>(166)</sup>	100	37	740
	6	120	38	760
$ m V_{OD}$ differential peak to peak typical	7	140	39	780
	8	160	40	800
	9	180	41	820
	10	200	42	840
	11	220	43	860
	12	240	44	880
	13	260	45	900
	14	280	46	920

<sup>(166)</sup> If TX termination resistance = 100  $\Omega$ , this VOD setting is illegal.





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Symbol	Parameter	Min	Тур	Мах	Unit
t <sub>INCCJ</sub> <sup>(171)</sup> , <sup>(172)</sup>	Input clock cycle-to-cycle jitter (f_{REF} $\geq 100~MHz)$	—	_	0.15	UI (p-p)
'INCCJ , , , , ,	Input clock cycle-to-cycle jitter ( $f_{REF} < 100 \text{ MHz}$ )	-750		+750	ps (p-p)
t <sub>outpj_dc</sub> <sup>(173)</sup>	Period Jitter for dedicated clock output in integer PLL ( $f_{OUT} \ge 100 \text{ MHz}$ )	_	_	175	ps (p-p)
COUTPJ_DC	Period Jitter for dedicated clock output in integer PLL (f <sub>OUT</sub> < 100 Mhz)	_		17.5	mUI (p-p)
(173)	Period Jitter for dedicated clock output in fractional PLL ( $f_{OUT} \ge 100 \text{ MHz}$ )	_		$250^{(176)}, \\ 175^{(174)}$	ps (p-p)
t <sub>FOUTPJ_DC</sub> <sup>(173)</sup>	Period Jitter for dedicated clock output in fractional PLL (f <sub>OUT</sub> < 100 MHz)	—		$25^{(176)}$ , 17.5 <sup>(174)</sup>	mUI (p-p)
tournoon = c (173)	Cycle-to-cycle Jitter for a dedicated clock output in integer PLL ( $f_{OUT} \ge 100 \text{ MHz}$ )	—		175	ps (p-p)
t <sub>outccj_dc</sub> <sup>(173)</sup>	Cycle-to-cycle Jitter for a dedicated clock output in integer PLL ( $f_{OUT} < 100 \text{ MHz}$ )	_		17.5	mUI (p-p)
t <sub>FOUTCCJ_DC</sub> <sup>(173)</sup>	Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ( $f_{OUT} \ge 100 \text{ MHz}$ )	—		250 <sup>(176)</sup> , 175 <sup>(174)</sup>	ps (p-p)
	Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ( $f_{OUT} < 100 \text{ MHz}$ )			$25^{(176)}$ , 17.5 <sup>(174)</sup>	mUI (p-p)

<sup>(171)</sup> A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source with jitter < 120 ps. <sup>(172)</sup> The  $f_{REF}$  is fIN/N specification applies when N = 1.

<sup>(174)</sup> This specification only covered fractional PLL for low bandwidth. The  $f_{VCO}$  for fractional value range 0.20–0.80 must be  $\geq$  1200 MHz.



<sup>(173)</sup> Peak-to-peak jitter with a probability level of 10<sup>-12</sup> (14 sigma, 99.999999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in the "Worst-Case DCD on Arria V GZ I/O Pins" table.

#### 2-42 Memory Block Specifications

Mode	Performar	nce		Unit		
imoue	C3, I3L	C4	14	Onit		
One sum of two $27 \times 27$	380	300	290	MHz		
One sum of two $36 \times 18$	380	300		MHz		
One complex 18 × 18	400	350		MHz		
One 36 × 36	380	300		MHz		
Modes using Three DSP Blocks		•				
One complex 18 × 25	340	275 265		MHz		
Modes using Four DSP Blocks						
One complex $27 \times 27$	350	31	MHz			

#### **Memory Block Specifications**

#### Table 2-36: Memory Block Performance Specifications for Arria V GZ Devices

To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.

When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F<sub>MAX</sub>.

Memory	Memory Mode		rces Used	Performance				Unit
Memory	Moue	ALUTs	Memory	C3	C4	I3L	14	
	Single port, all supported widths	0	1	400	315	400	315	MHz
MLAB	Simple dual-port, x32/x64 depth	0	1	400	315	400	315	MHz
WILAD	Simple dual-port, x16 depth (178)	0	1	533	400	533	400	MHz
	ROM, all supported widths	0	1	500	450	500	450	MHz

<sup>(178)</sup> The F<sub>MAX</sub> specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.



Symbol	Conditions		C3, I3L			C4, I4		
Symbol	Conditions	Min	Тур	Мах	Min	Тур	Max	Unit
	SERDES factor J = 3 to 10 (182), (183)	(184)	_	1250	(184)	_	1050	Mbps
True Differential I/O Standards - f <sub>HSDR</sub> (data rate)	SERDES factor $J \ge 4$ LVDS TX with DPA (185), (186), (187), (188)	(184)		1600	(184)		1250	Mbps
	SERDES factor J = 2, uses DDR Registers	(184)		(189)	(184)		(189)	Mbps
	SERDES factor J = 1, uses SDR Register	(184)	_	(189)	(184)		(189)	Mbps
Emulated Differential I/O Standards with Three External Output Resistor Networks - f <sub>HSDR</sub> (data rate) (190)	SERDES factor J = 4 to 10 <sup>(191)</sup>	(184)		840	(184)		840	Mbps

<sup>&</sup>lt;sup>(182)</sup> If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.

- <sup>(185)</sup> Arria V GZ RX LVDS will need DPA. For Arria V GZ TX LVDS, the receiver side component must have DPA.
- Requires package skew compensation with PCB trace length. (186)
- (187)Do not mix single-ended I/O buffer within LVDS I/O bank.
- Chip-to-chip communication only with a maximum load of 5 pF. (188)
- <sup>(189)</sup> The maximum ideal data rate is the SERDES factor (J) x the PLL maximum output frequency (fOUT) provided you can close the design timing and the signal integrity simulation is clean.
- <sup>(190)</sup> You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.
- <sup>(191)</sup> When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.



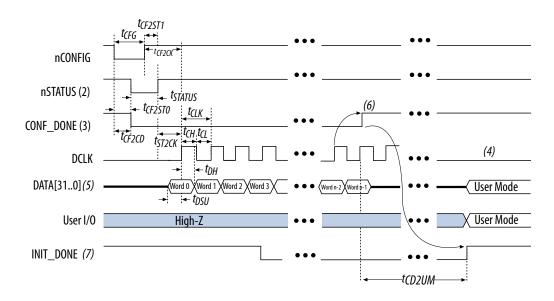
<sup>&</sup>lt;sup>(183)</sup> The  $F_{MAX}$  specification is based on the fast clock used for serial data. The interface  $F_{MAX}$  is also dependent on the parallel clock domain which is design dependent and requires timing analysis.

<sup>&</sup>lt;sup>(184)</sup> The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.

#### FPP Configuration Timing when DCLK to DATA[] = 1

#### Figure 2-7: FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is 1

Timing waveform for FPP configuration when using a MAX<sup>®</sup> II or MAX V device as an external host.



Notes:

- 1. The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF\_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- 2. After power-up, the Arria V GZ device holds nSTATUS low for the time of the POR delay.
- 3. After power-up, before and during configuration, CONF\_DONE is low.
- 4. Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- 5. For FPP ×16, use DATA[15..0]. For FPP ×8, use DATA[7..0]. DATA[31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- 6. To ensure a successful configuration, send the entire configuration data to the Arria V GZ device. CONF\_DONE is released high when the Arria V GZ device receives all the configuration data successfully. After CONF\_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- 7. After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

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#### Table 2-57: FPP Timing Parameters for Arria V GZ Devices When the DCLK-to-DATA[] Ratio is >1

Use these timing parameters when you use the decompression and design security features.

Symbol	Parameter	Minimum	Maximum	Unit
t <sub>CF2CD</sub>	nconfig low to conf_done low	-	600	ns
t <sub>CF2ST0</sub>	nconfig low to nstatus low	-	600	ns
t <sub>CFG</sub>	nCONFIG low pulse width	2	_	μs
t <sub>STATUS</sub>	nSTATUS low pulse width	268	1,506 (210)	μs
t <sub>CF2ST1</sub>	nCONFIG high to nSTATUS high	—	1,506 (211)	μs
t <sub>CF2CK</sub> <sup>(212)</sup>	nCONFIG high to first rising edge on DCLK	1,506	_	μs
t <sub>ST2CK</sub> <sup>(212)</sup>	nSTATUS high to first rising edge of DCLK	2	_	μs
t <sub>DSU</sub>	DATA[] setup time before rising edge on DCLK	5.5	_	ns
t <sub>DH</sub>	DATA[] hold time after rising edge on DCLK	N-1/f <sub>DCLK</sub> <sup>(213)</sup>	_	S
t <sub>CH</sub>	DCLK high time	$0.45  imes 1/f_{MAX}$	_	S
t <sub>CL</sub>	DCLK low time	$0.45 \times 1/f_{MAX}$	_	S
t <sub>CLK</sub>	DCLK period	1/f <sub>MAX</sub>	_	S
£	DCLK frequency (FPP ×8/×16)	-	125	MHz
$f_{MAX}$	DCLK frequency (FPP ×32)	-	100	MHz
t <sub>R</sub>	Input rise time	-	40	ns
t <sub>F</sub>	Input fall time	-	40	ns
t <sub>CD2UM</sub>	CONF_DONE high to user mode <sup>(214)</sup>	175	437	μs

<sup>(210)</sup> You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.

<sup>(211)</sup> You can obtain this value if you do not delay configuration by externally holding the nSTATUS low.

 $^{(212)}$  If nSTATUS is monitored, follow the  $t_{ST2CK}$  specification. If nSTATUS is not monitored, follow the  $t_{CF2CK}$  specification.

 $^{(213)}$  N is the DCLK-to-DATA ratio and  $f_{DCLK}$  is the DCLK frequency the system is operating.

<sup>(214)</sup> The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.

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**Altera Corporation** 



Date	Version	Changes
July 2014	3.8	<ul> <li>Updated Table 21.</li> <li>Updated Table 22 V<sub>OCM</sub> (DC Coupled) condition.</li> <li>Updated the DCLK note to Figure 6, Figure 7, and Figure 9.</li> <li>Added note to Table 5 and Table 6.</li> <li>Added the DCLK specification to Table 50.</li> <li>Added note to Table 51.</li> <li>Updated the list of parameters in Table 53.</li> </ul>
February 2014	3.7	Updated Table 28.
December 2013	3.6	<ul> <li>Updated Table 2, Table 13, Table 18, Table 19, Table 22, Table 30, Table 33, Table 37, Table 38, Table 45, Table 46, Table 47, Table 56, Table 49.</li> <li>Updated "PLL Specifications".</li> </ul>
August 2013	3.5	Updated Table 28.
August 2013	3.4	<ul> <li>Removed Preliminary tags for Table 2, Table 4, Table 5, Table 14, Table 27, Table 28, Table 29, Table 31, Table 32, Table 43, Table 45, Table 46, Table 47, Table 48, Table 49, Table 50, and Table 54.</li> <li>Updated Table 2 and Table 28.</li> </ul>
June 2013	3.3	Updated Table 23, Table 28, Table 51, and Table 55.
May 2013	3.2	<ul> <li>Added Table 23.</li> <li>Updated Table 5, Table 22, Table 26, and Table 57.</li> <li>Updated Figure 6, Figure 7, Figure 8, and Figure 9.</li> </ul>
March 2013	3.1	<ul> <li>Updated Table 2, Table 6, Table 7, Table 8, Table 19, Table 22, Table 26, Table 29, Table 52.</li> <li>Updated "Maximum Allowed Overshoot and Undershoot Voltage".</li> </ul>
December 2012	3.0	Initial release.

